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Kind regards,

Team Nexperia

DATA SHEET

74F32

Quad 2-input OR gate

Product specification
Supersedes data of 1990 Oct 04
IC15 Data Handbook

2000 Aug 02

Quad 2-input OR gate

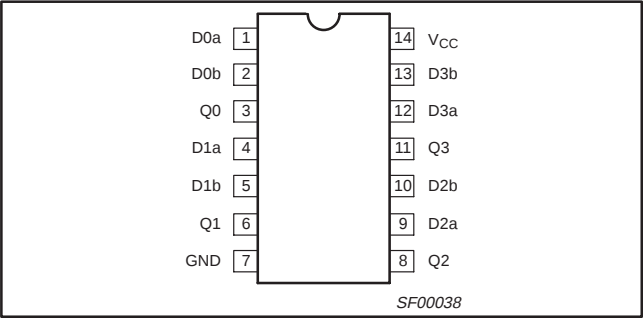
74F32

FEATURE

- Industrial temperature range available (−40°C to +85°C)

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F32	4.1ns	8.2mA

PIN CONFIGURATION



ORDERING INFORMATION

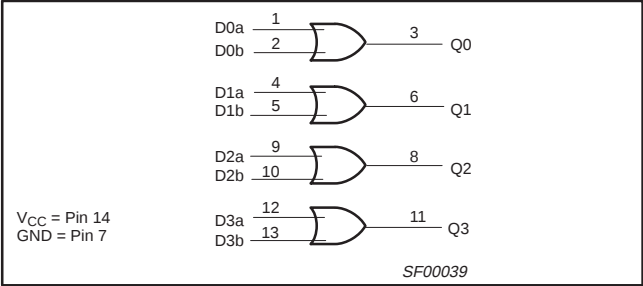
DESCRIPTION	ORDER CODE		PKG DWG #
	COMMERCIAL RANGE V _{CC} = 5V ±10%, T _{amb} = 0°C to +70°C	INDUSTRIAL RANGE V _{CC} = 5V ±10%, T _{amb} = −40°C to +85°C	
14-pin plastic DIP	N74F32N	I74F32N	SOT27-1
14-pin plastic SO	N74F32D	I74F32D	SOT108–1

INPUT AND OUTPUT LOADING AND FAN OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
Dna, Dnb	Data inputs	1.0/1.0	20µA/0.6mA
Qn	Data output	50/33	1.0mA/20mA

NOTE: One (1.0) FAST unit load is defined as: 20µA in the high state and 0.6mA in the low state.

LOGIC DIAGRAM

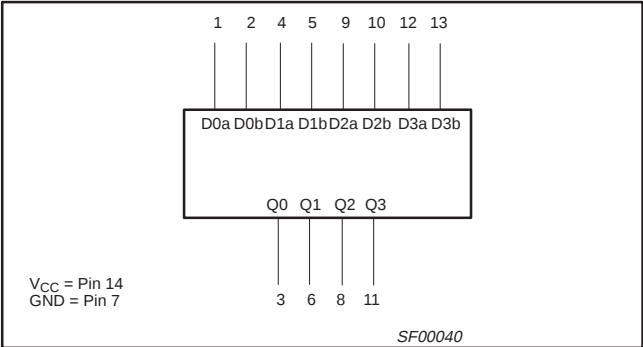


FUNCTION TABLE

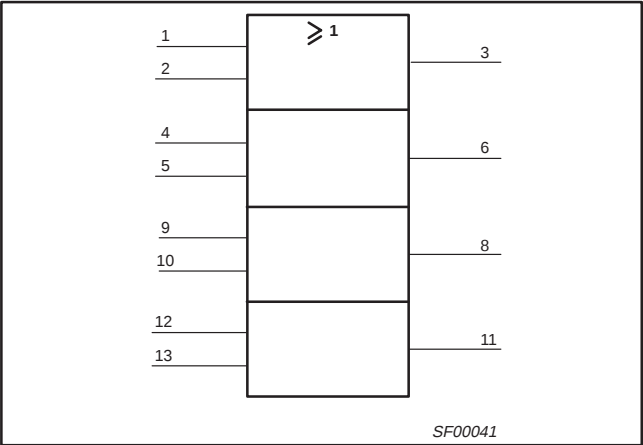
INPUTS		OUTPUT
Dna	Dnb	Qn
L	L	L
L	H	H
H	L	H
H	H	H

- NOTES:
- 1 H = High voltage level
 - 2 L = Low voltage level

LOGIC SYMBOL



IEC/IEEE SYMBOL



Quad 2-input OR gate

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ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device.
Unless otherwise noted these limits are over the operating free air temperature range.)

SYMBOL	PARAMETER		RATING	UNIT
V_{CC}	Supply voltage		-0.5 to +7.0	V
V_{IN}	Input voltage		-0.5 to +7.0	V
I_{IN}	Input current		-30 to +5	mA
V_{OUT}	Voltage applied to output in high output state		-0.5 to V_{CC}	V
I_{OUT}	Current applied to output in low output state		40	mA
T_{amb}	Operating free air temperature range	Commercial range	0 to +70	°C
		Industrial range	-40 to +85	°C
T_{stg}	Storage temperature range		-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		LIMITS			UNIT
			MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5.0	5.5	V
V_{IH}	High-level input voltage		2.0			V
V_{IL}	Low-level input voltage				0.8	V
I_{IK}	Input clamp current				-18	mA
I_{OH}	High-level output current				-1	mA
I_{OL}	Low-level output current				20	mA
T_{amb}	Operating free air temperature range	Commercial range	0		+70	°C
		Industrial range	-40		+85	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDITIONS ¹		LIMITS			UNIT
					MIN	TYP ²	MAX	
V_{OH}	High-level output voltage		$V_{CC} = \text{MIN}, V_{IL} = \text{MAX}$	$\pm 10\%V_{CC}$	2.5			V
			$V_{IH} = \text{MIN}, I_{OH} = \text{MAX}$	$\pm 5\%V_{CC}$	2.7	3.4		V
V_{OL}	Low-level output voltage		$V_{CC} = \text{MIN}, V_{IL} = \text{MAX}$	$\pm 10\%V_{CC}$		0.30	0.50	V
			$V_{IH} = \text{MIN}, I_{OL} = \text{MAX}$	$\pm 5\%V_{CC}$		0.30	0.50	V
V_{IK}	Input clamp voltage		$V_{CC} = \text{MIN}, I_I = I_{IK}$			-0.73	-1.2	V
I_I	Input current at maximum input voltage		$V_{CC} = \text{MAX}, V_I = 7.0\text{V}$				100	μA
I_{IH}	High-level input current		$V_{CC} = \text{MAX}, V_I = 2.7\text{V}$				20	μA
I_{IL}	Low-level input current		$V_{CC} = \text{MAX}, V_I = 0.5\text{V}$				-0.6	mA
I_{OS}	Short-circuit output current ³		$V_{CC} = \text{MAX}$		-60		-150	mA
I_{CC}	Supply current (total)	I_{CCH}	$V_{CC} = \text{MAX}$	$V_{IN} = 4.5\text{V}$		6.1	9.2	mA
		I_{CCL}	$V_{CC} = \text{MAX}$	$V_{IN} = \text{GND}$		10.3	15.5	mA

NOTES:

- For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- All typical values are at $V_{CC} = 5\text{V}$, $T_{amb} = 25^\circ\text{C}$.
- Not more than one output should be shorted at a time. For testing I_{OS} , the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

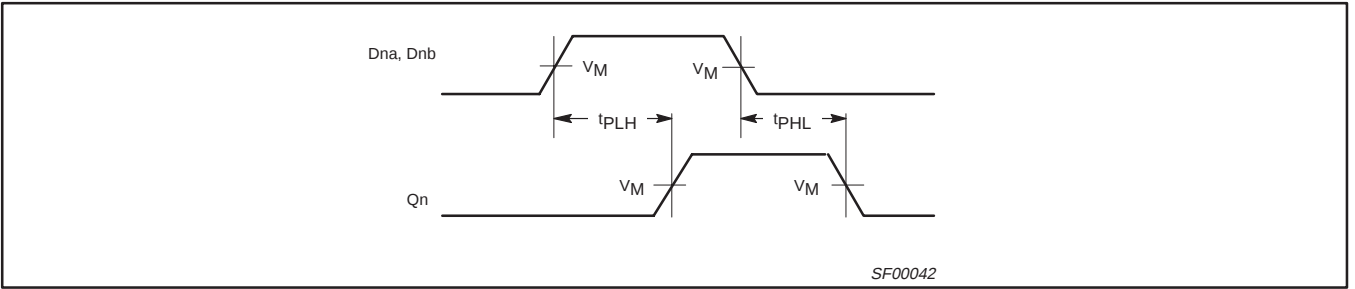
Quad 2-input OR gate

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AC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITION	LIMITS							UNIT
			V _{CC} = +5.0V T _{amb} = +25°C C _L = 50pF, R _L = 500Ω			V _{CC} = +5.0V ± 10% T _{amb} = 0°C to +70°C C _L = 50pF, R _L = 500Ω		V _{CC} = +5.0V ± 10% T _{amb} = −40°C to +85°C C _L = 50pF, R _L = 500Ω		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay Dna, Dnb to Qn	Waveform 1	3.0 3.0	4.2 4.0	5.6 5.3	3.0 3.0	6.6 6.3	3.0 3.0	6.6 6.3	ns

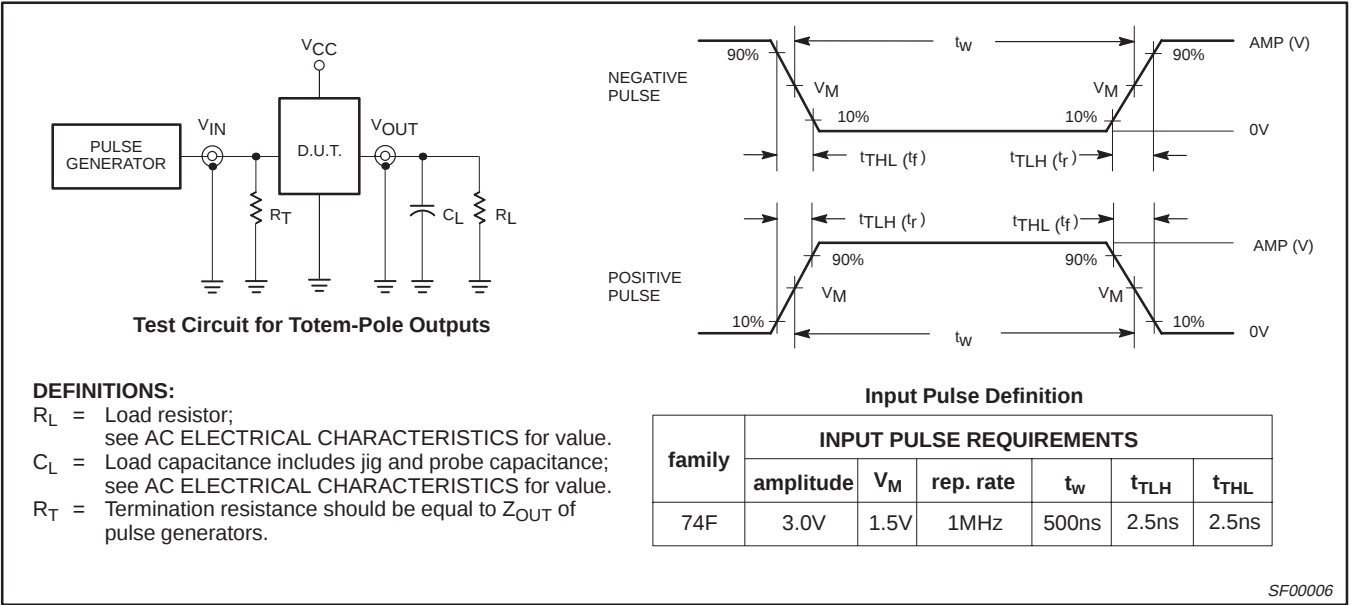
AC WAVEFORMS



Waveform 1. Propagation delay for inverting outputs

NOTE:
For all waveforms, $V_M = 1.5V$.

TEST CIRCUIT AND WAVEFORMS

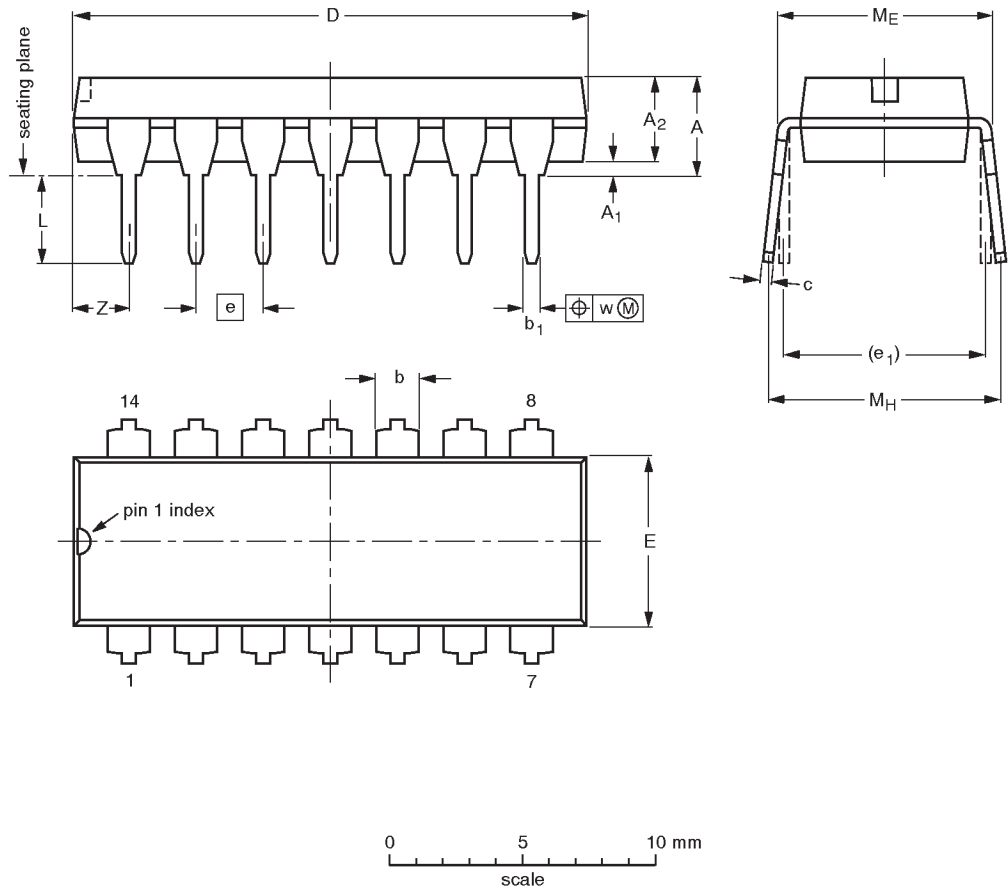


Quad 2-input OR gate

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DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

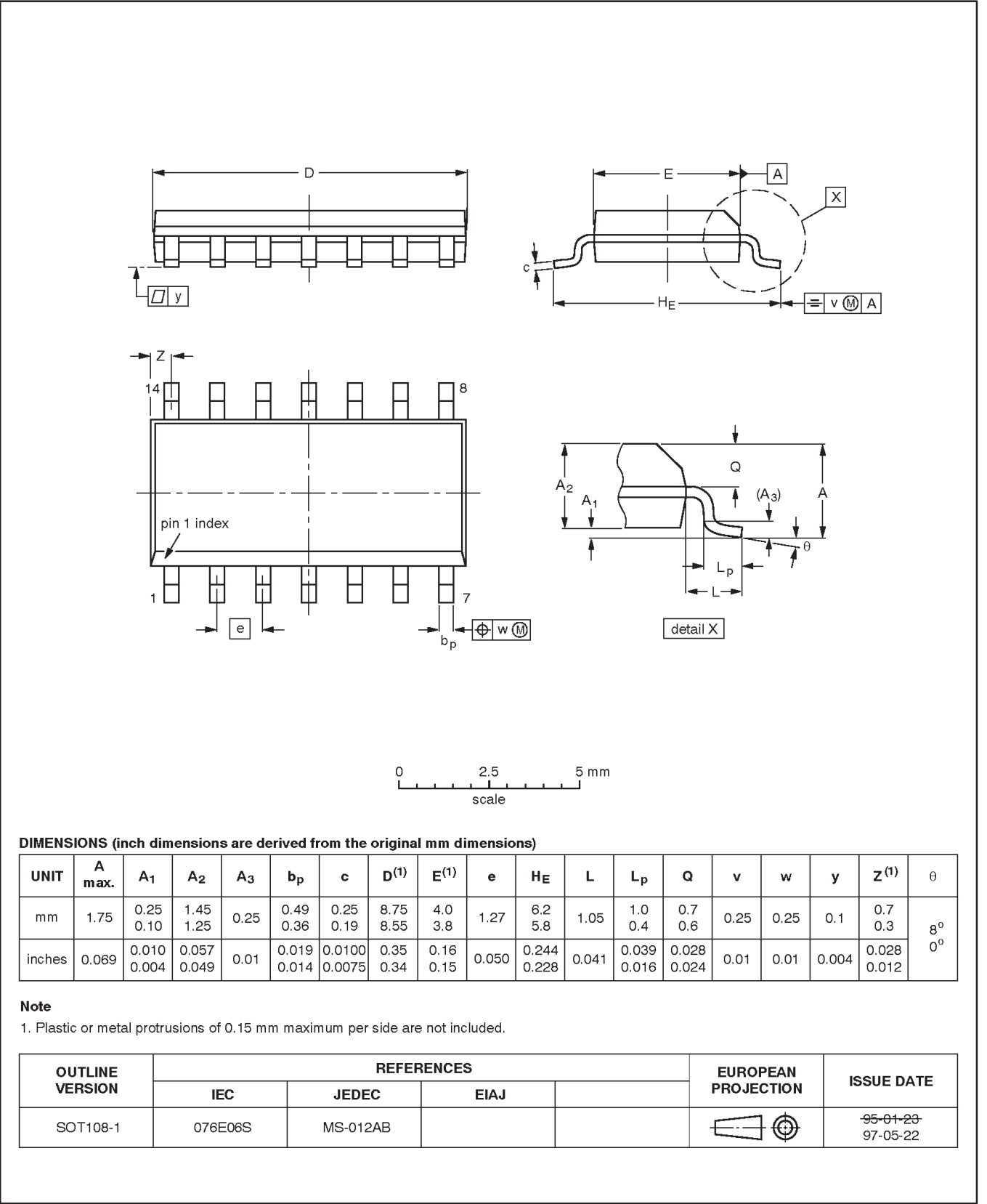
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT27-1	050G04	MO-001AA				92-11-17 95-03-11

Quad 2-input OR gate

74F32

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



Quad 2-input OR gate**74F32**

NOTES

Quad 2-input OR gate

74F32

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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print code

Date of release: 08-00

Document order number:

9397-750-07379

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